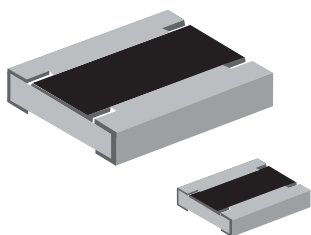


Long Side Termination Thick Film Chip Resistors



FEATURES

- Enhanced power rating
- Long side terminations
- Pure tin solder contacts on Ni barrier layer, provides compatibility with lead (Pb)-free and lead containing soldering processes
- Compliant to RoHS Directive 2002/95/EC
- Halogen-free according to IEC 61249-2-21 definition
- AEC-Q200 qualified



RoHS
COMPLIANT
HALOGEN
FREE

STANDARD ELECTRICAL SPECIFICATIONS

MODEL	SIZE		RATED DISSIPATION P_{70} W	LIMITING ELEMENT VOLTAGE $U_{max. AC/DC}$ V	TEMPERATURE COEFFICIENT ppm/K	TOLERANCE %	RESISTANCE RANGE Ω	SERIES
	INCH	METRIC						
RCL0612 e3	0612	RR 1632M	0.5	75	± 100	± 1	1R0 to 1M	E24; E96
					± 200	± 5		E24
RCL1218 e3	1218	RR 3246M	1.0	200	± 100	± 1	1R0 to 2.2M	E24; E96
					± 200	± 5		E24
RCL1225 e3	1225	RR 3263M	2.0 ⁽¹⁾	200	± 100	± 1	1R0 to 1M	E24; E96
					± 200	± 5		E24

Notes

- These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.
 - Marking: See datasheet "Surface Mount Resistor Marking" (document number 20020).
 - Power rating depends on the max. temperature at the solder point, the component placement density and the substrate material.
- ⁽¹⁾ Specified power rating requires dedicated mounting conditions to achieve the required thermal resistance.

TECHNICAL SPECIFICATIONS

DESCRIPTION	UNIT	RCL0612	RCL1218	RCL1225
Rated Dissipation P_{70} ⁽²⁾	W	0.5	1.0	2.0 ⁽³⁾
Limiting Element Voltage $U_{max. AC/DC}$	V	75	200	200
Insulation Voltage U_{ins} (1 min)	V	> 100	> 300	> 300
Insulation Resistance	Ω	> 10^9		
Category Temperature Range	$^{\circ}\text{C}$	- 55 to + 155		
Weight	mg	11	29.5	55

Notes

- ⁽²⁾ The power dissipation on the resistors generates a temperature rise against the local ambient, depending on the heat flow support of the printed-circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature of 155 $^{\circ}\text{C}$ is not exceeded.
- ⁽³⁾ Specified power rating requires dedicated mounting conditions to achieve the required thermal resistance.

PART NUMBER AND PRODUCT DESCRIPTION

PART NUMBER: RCL061210K0FKEA

R C L 0 6 1 2 1 0 K 0 F K E A 0 0

MODEL/SIZE	RESISTANCE	TOLERANCE	TCR	PACKAGING	SPECIAL
RCL0612 RCL1218 RCL1225	R = Decimal K = Thousand M = Million 0000 = Jumper	F = $\pm 1\%$ J = $\pm 5\%$ Z = Jumper	K = ± 100 ppm/K N = ± 200 ppm/K 0 = Jumper	EA EB EC EK EG	Up to 2 digits 00 = Standard

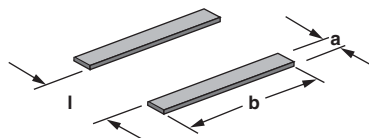
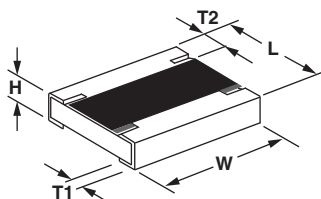
PRODUCT DESCRIPTION: RCL0612 100 10K 1% ET1 e3

RCL0612	100	10K	1%	ET1	e3
MODEL RCL0612 RCL1218 RCL1225	TCR ± 100 ppm/K ± 200 ppm/K	RESISTANCE 10R = 10 Ω 10K = 10 k Ω 1M = 1 M Ω 0R0 = Jumper	TOLERANCE $\pm 1\%$ $\pm 5\%$	PACKAGING ET1 ET5 ET6 ET9 E67	LEAD (Pb)-FREE e3 = Pure tin termination finish

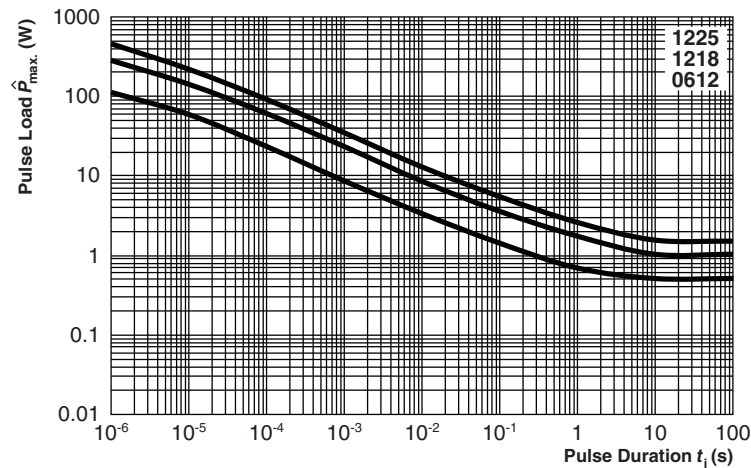
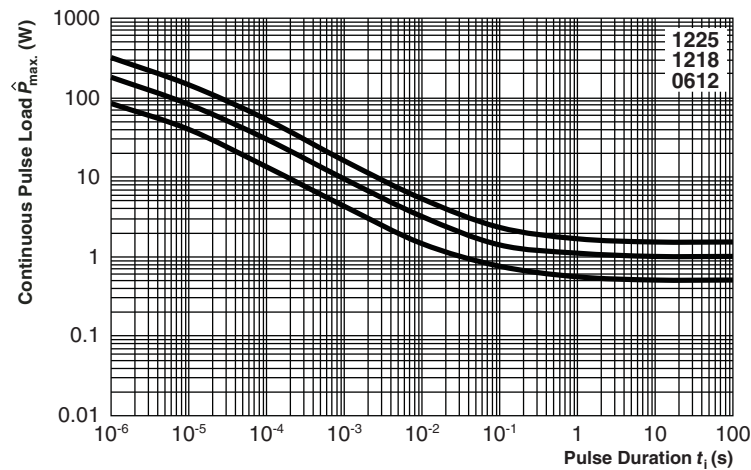
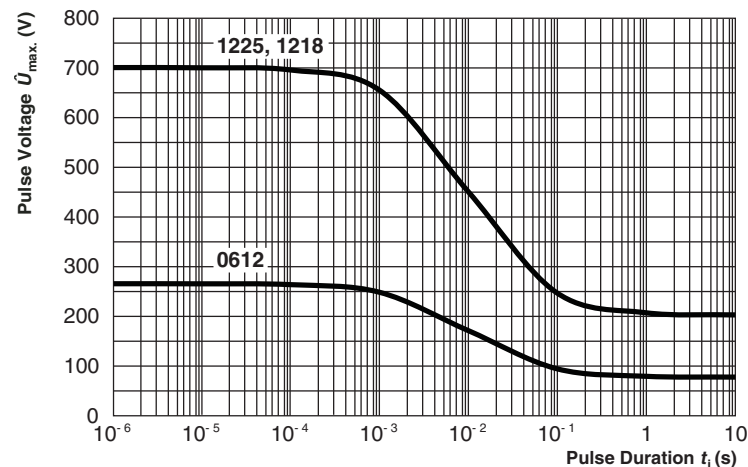
PACKAGING

MODEL	UNIT	PAPER TAPE ON REEL ACC. TO IEC 60286-3, TYPE I			BLISTER TAPE ON REEL ACC. TO IEC 60286-3, TYPE II		
		QUANTITY	PART NUMBER	PRODUCT DESC.	QUANTITY	PART NUMBER	PRODUCT DESC.
RCL0612	180 mm/7"	5000	EA	ET1			
	285 mm/11.25"	10 000	EB	ET5			
	330 mm/13"	20 000	EC	ET6			
RCL1218	180 mm/7"				4000	EK	ET9
RCL1225	180 mm/7"				2000	EG	E67

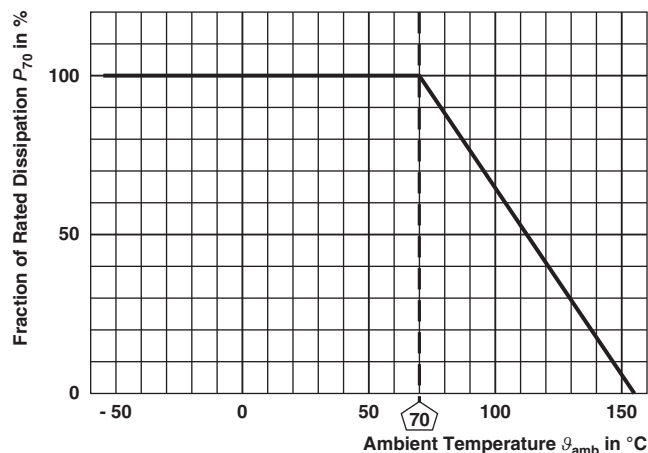
DIMENSIONS in millimeters



SIZE		DIMENSIONS					SOLDER PAD DIMENSIONS					
							REFLOW SOLDERING			WAVE SOLDERING		
INCH	METRIC	L	W	H	T1	T2	a	b	l	a	b	l
0612	1632	1.6 $\pm$ 0.2	3.2 $\pm$ 0.2	0.55 $\pm$ 0.1	0.35 $\pm$ 0.15	0.25 $\pm$ 0.15	0.6	3.2	1.0	1.1	3.2	1.0
1218	3246	3.2 $^{+0.10}_{-0.20}$	4.6 $\pm$ 0.15	0.55 $\pm$ 0.05	0.45 $\pm$ 0.2	0.4 $\pm$ 0.2	1.1	4.9	1.9	1.25	4.8	1.9
1225	3263	3.2 $\pm$ 0.2	6.3 $\pm$ 0.2	0.75 $\pm$ 0.15	0.8 $\pm$ 0.2	0.4 $\pm$ 0.2	1.9	7.6	1.2	1.9	7.6	1.2

FUNCTIONAL PERFORMANCE
Single Pulse

Continuous Pulse

Pulse Voltage


Derating



TEST PROCEDURES AND REQUIREMENTS

EN 60115-1 CLAUSE		IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
					STABILITY CLASS 2 OR BETTER	
			Stability for product types:	1 Ω to 2.2 M Ω		
			RCL e3			
4.5	-	Resistance	-	$\pm 1 \%$	$\pm 5 \%$	
4.7	-	Voltage proof	$U = 1.4 \times U_{\text{ins}}$; 60 s	No flashover or breakdown		
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{\text{max}}$; Duration acc. to style	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$	
4.17.2	58 (Td)	Solderability	Solder bath method; Sn60Pb40 non activated flux; (235 $\pm$ 5) $^{\circ}\text{C}$ (2 $\pm$ 0.2) s	Good tinning ($\geq 95 \%$ covered); no visible damage		
			Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; (245 $\pm$ 5) $^{\circ}\text{C}$ (3 $\pm$ 0.3) s	Good tinning ($\geq 95 \%$ covered); no visible damage		
4.8.4.2	-	Temperature coefficient	(20/- 55/20) $^{\circ}\text{C}$ and (20/125/20) $^{\circ}\text{C}$	$\pm 100 \text{ ppm/K}$	$\pm 200 \text{ ppm/K}$	
4.32	21 (Uu ₃)	Shear (adhesion)	45N	No visible damage		
4.33	21 (Uu ₁)	Substrate bending	Depth 2 mm; 3 times	No visible damage, no open circuit in bent position $\pm (0.25 \% R + 0.05 \Omega)$		
4.19	14 (Na)	Rapid change of temperature	30 min at - 55 $^{\circ}\text{C}$; 30 min at 125 $^{\circ}\text{C}$			
			5 cycles	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$	
			1000 cycles	$\pm (1 \% R + 0.05 \Omega)$	$\pm (1 \% R + 0.05 \Omega)$	

TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (ΔR)	
				STABILITY CLASS 2 OR BETTER	
			Stability for product types:	1 Ω to 2.2 M Ω	
			RCL e3		
4.23 4.23.2 4.23.3 4.23.4 4.23.5 4.23.6 4.23.7	- 2 (Ba) 30 (Db) 1 (Aa) 13 (M) 30 (Db) -	Climatic sequence: Dry heat Damp heat, cyclic Cold Low air pressure Damp heat, cyclic DC load	- 125 °C; 16 h 55 °C; ≥ 90 % RH; 24 h; 1 cycle - 55 °C; 2 h 1 kPa; (25 $\pm$ 10) °C; 1 h 55 °C; ≥ 90 % RH; 24 h; 5 cycles $U = \sqrt{P_{70}} \times R$	$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
4.25.1	-	Endurance at 70 °C	$U = \sqrt{P_{70}} \times R \leq U_{\max.}$; 1.5 h on; 0.5 h off; 70 °C; 1000 h 70 °C; 8000 h	$\pm (0.5 \% R + 0.05 \Omega)$ $\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$ $\pm (4 \% R + 0.1 \Omega)$
4.18.2	58 (Td)	Resistance to soldering heat	Solder bath method (260 $\pm$ 5) °C; (10 $\pm$ 1) s	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
4.35	-	Flamability, needle flame test	IEC 60695-11-5; 10 s	No burning after 30 s	
4.24	78 (Cab)	Damp heat, steady state	(40 $\pm$ 2) °C; (93 $\pm$ 3) % RH; 56 days	$\pm (1 \% R + 0.05 \Omega)$	
4.25.3	-	Endurance at upper category temperature	155 °C, 1000 h	$\pm (1 \% R + 0.05 \Omega)$	$\pm (2 \% R + 0.1 \Omega)$
4.40	-	Electrostatic discharge (Human Body Model)	IEC 61340-3-1 3 pos. + 3 neg. discharges; ESD voltage: 1000 V	$\pm (1 \% R + 0.05 \Omega)$	
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage	
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1, toothbrush	Marking legible, no visible damage	
4.22	6 (Fc)	Vibration, endurance by sweeping	f = 10 Hz to 2000 Hz; x, y, z ≤ 1.5 mm; A ≤ 200 m/s ² ; 10 sweeps per axis	$\pm (0.25 \% R + 0.05 \Omega)$	$\pm (0.5 \% R + 0.05 \Omega)$
4.37	-	Periodic electric overload	$U = \sqrt{15 \times P_{70} \times R}$ $\leq 2 \times U_{\max.}$; 0.1 s on; 2.5 s off; 1000 cycles	$\pm (1 \% R + 0.05 \Omega)$	
4.27	-	Single pulse high voltage overload, 10 μ s/700 μ s	$\hat{U} = 10 \times \sqrt{P_{70} \times R}$ $\leq 2 \times U_{\max.}$; 10 pulses	$\pm (1 \% R + 0.05 \Omega)$	

All tests are carried out in accordance with the following specifications:

- EN 60115-1, generic specification
- EN 140400, sectional specification
- EN 140401-802, detail specification
- IEC 60068-2-x environmental test procedures

Packaging of components is done in paper or blister tapes according to IEC 60286-3



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